

SPACE TRANSPORTATION

MEMSRAD – MEMS Sensitivity to Space Radiation

C. OUDEA (Astrium-Space Transportation)

O. VENDIER (Thales Alenia Space)

R. GAILLARD & P. POIROT (Infoduc)

27th January 2009 at PSI, Switzerland

All the space you need

ESA – CNES QCA Day at PSI – 27-28/01/2009

C. OUDEA – Astrium ST



Outline

- Introduction
- MEMSRAD Goal
- MEMS Selection Criteria
- Selected MEMS Presentations
 - Accelerometers
 - RF MEMS
- Preliminary Results
 - Accelerometers
 - RF MEMS
- Conclusions

This document is the property of Astrium. It shall not be communicated to third parties without prior written agreement. Its content shall not be disclosed.

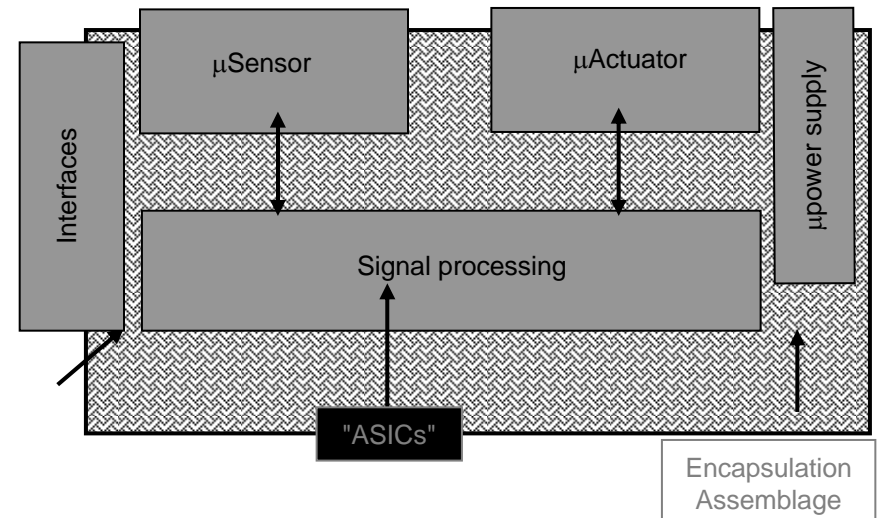
Introduction (1/3)

- **MEMSRAD Contract**
 - ESA/ESTEC Contract n°: 20293/06/NL/CP
 - Duration : 24 months
- **Members of Consortium**
 - EADS - Astrium Space Transportation : Prime
 - Sub Contractors:
 - EADS Innovative Works, Ottobrun (Ge)
 - Thales Alenia Space, Toulouse (Fr)
 - Infoduc (Fr)

This document is the property of Astrium. It shall not be communicated to third parties without prior written agreement. Its content shall not be disclosed.

Introduction (2/3)

- MEMS :
 - A system with atleast 2 functions:
 - Sensor / Actuator + Signal treatment
 - Manufactured / assembled:
 - On a single wafer: monolithics,
 - With few wafers: hybride



USA

MEMS : Micro-ElectroMechanical Systems

MOEMS : Micro-OptoElectroMechanical Systems

JAPON

Micromachines

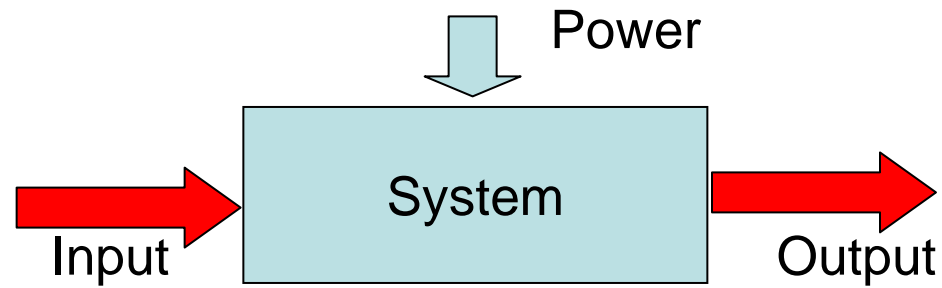
EUROPE

Microsystèmes

MST(MicroSystems Technology)

Introduction (3/3)

MEMS and Microelectronics



System	Input	Output
Microelectronic	Current, Voltage, frequency	Current, Voltage, frequency
MEMS Sensor	<i>Acceleration, Temperature, Rotation, Pressure</i>	Current, Voltage, frequency
MEMS Actuator	Current, Voltage	<i>Contact, Rotation, Translation,...</i>

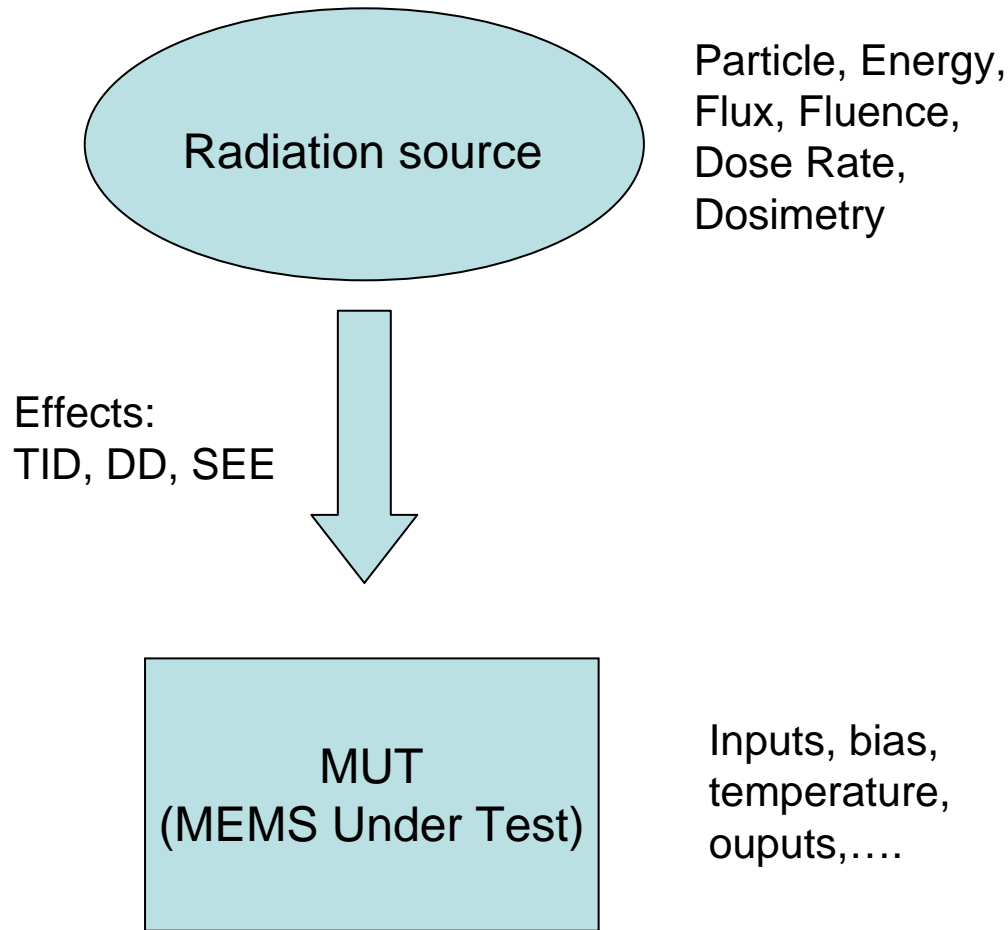
This document is the property of Astrium. It shall not be communicated to third parties without prior written agreement. Its content shall not be disclosed.

MEMSRAD GOAL (1/2)

Radiation Guidelines

- Purpose of this work
 - Prepare guidelines for Radiation Testing of MEMS
 - Help to perform characterization of MEMS and obtain meaningful results.
 - Allow different « End-Users » to share and compare results obtained with a common testing procedure.
- Methodology
 - Analysis of existing Radiation Testing Guidelines and Methods
 - Identification and Classification of MEMS
 - Identify important points to adapt or modify the guidelines
 - a priori
 - after performing tests on MEMS
 - Consider other Guidelines applied to MEMS:
 - Reliability evaluation
 - Specific testing methods related to the specific function

MEMSRAD GOAL (2/2) MEMS sensitivity to space RADiation



- ### Radiation Tests Facilities:
- Total dose: Co60 (ESA/ESTEC)
 - Single Event Effects
 - Heavy ions (UCL)
 - Protons (PSI)
 - Displacement Damage
 - Protons PSI (E=150MeV)

Selection criteria for MEMS (1/2)

Criteria:

- European source
- Matured Technology,
- Matured Product with high TRL for other applications
- Industrial production (avoid prototypes!)
- Availability
- Manufacturer cooperation (highly recommended)
 - Willingness to work for space applications
 - Providing samples
 - Providing sufficient technical informations (not a « black box »)
 - Possibility to exchange technical data's during the testing
 - Short & mid term participation
 - to improve the product, if necessary
 - appropriate packaging, redesign an ASIC (rad tolerant/hardened), etc.

Selection criteria for MEMS (2/2)

Criteria:

- Potential Space applications
- Past radiation experiences (internal, external)

- Expected radiation effects
 - TID (Total Induced Dose)
 - SEE (Single Event Effects)
 - DD (Displacement Damage)

- Availability of 2 type of MEMS at same time for radiation testing

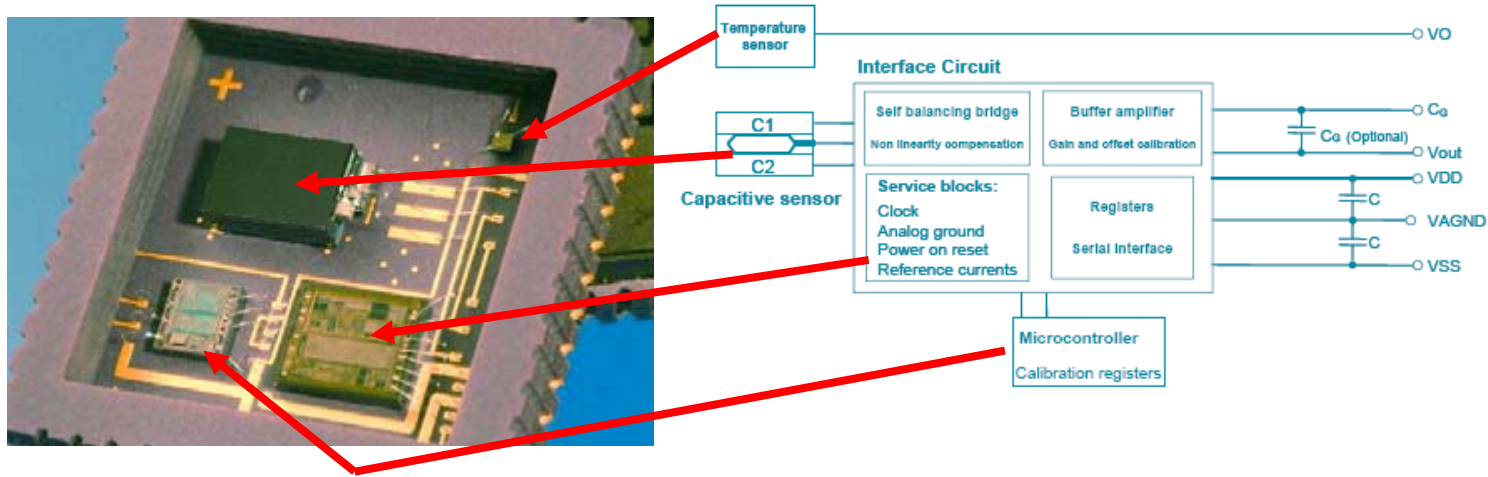
- Easy to test:
 - Before and after different radiation testing
 - Possibility to do the « on-line » parameters during different radiation testing

- Possibility to separate the contributions from:
 - Sensing element
 - Electronic circuits

- To allow the improvements in our « Radiation Guidelines » at the end of testing

SELECTED MEMS Presentation (1/2)

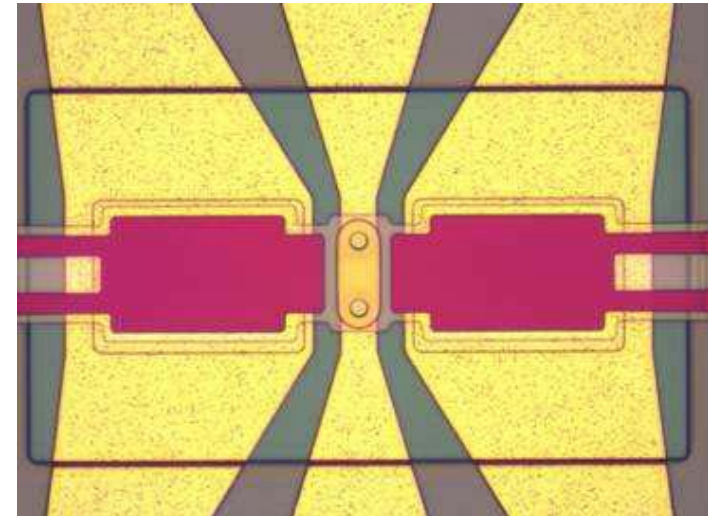
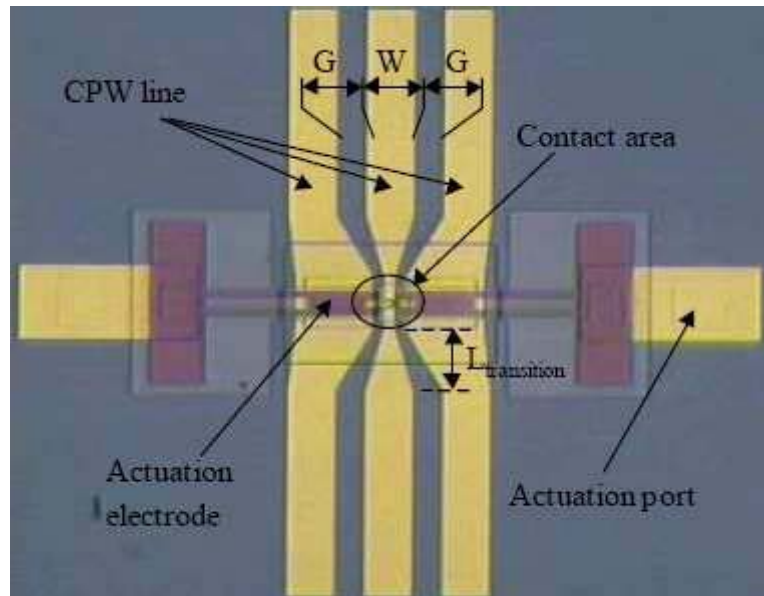
MEMS Type 1: Colibrys Accelerometer description



This document is the property of Astrium. It shall not be communicated to third parties without prior written agreement. Its content shall not be disclosed.

SELECTED MEMS Presentation (2/2)

MEMS Type 2: RF MEMS from LETI-CEA



Ohmic contact switch

This document is the property of Astrium. It shall not be communicated to third parties without prior written agreement. Its content shall not be disclosed.

Preliminary Results

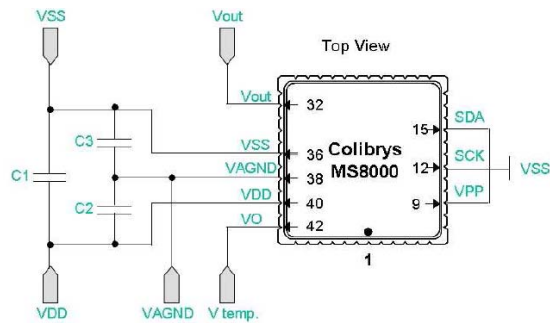
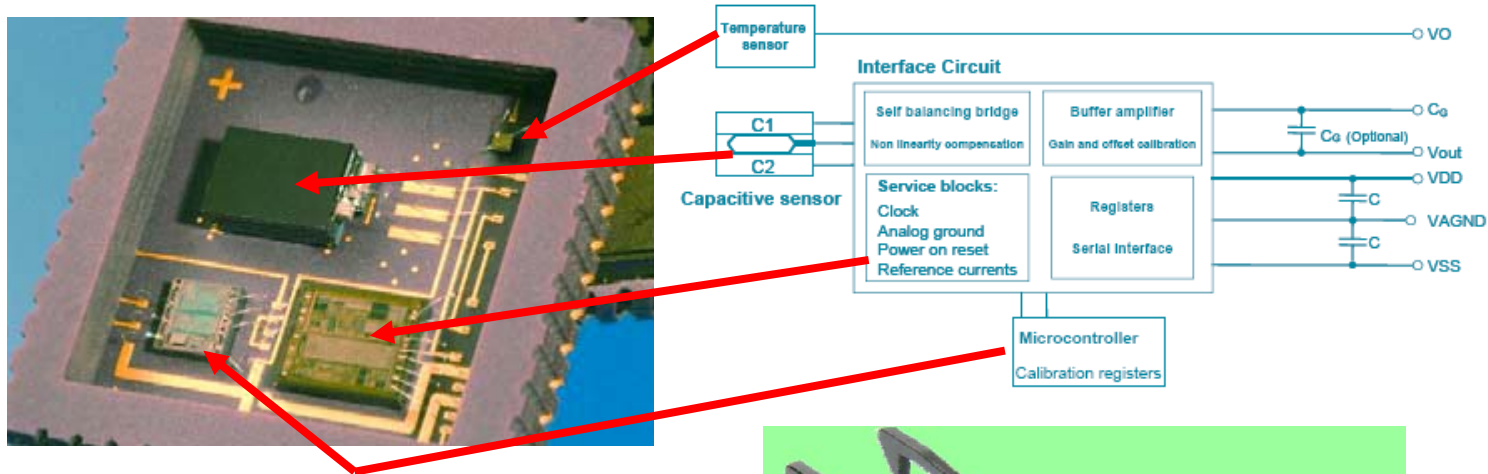
Test preparation: Initial measurements

- Obtain devices and verify the stability of the process
- Define or use standards on measurement procedures
 - Verify the homogeneity of a given lot
 - Verify the stability of the parameters:(sensitivity to temperature, humidity)
 - Verify the possibility to test the devices in the irradiation facility (package, thermal dissipation, mechanical state)
- Ex: Special adaptation:
 - Test Jig RF-MEMS
 - Accelerometer positioning

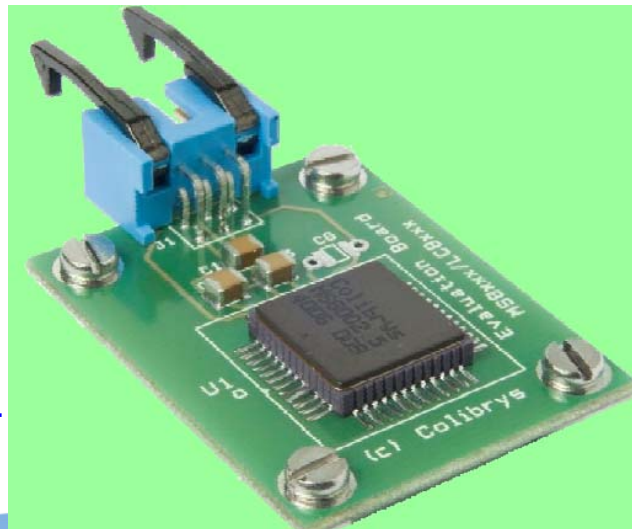
Preliminary Results

Accelerometers

DUT (Accelerometer) description:



$C1=C2=C3=1\mu F$



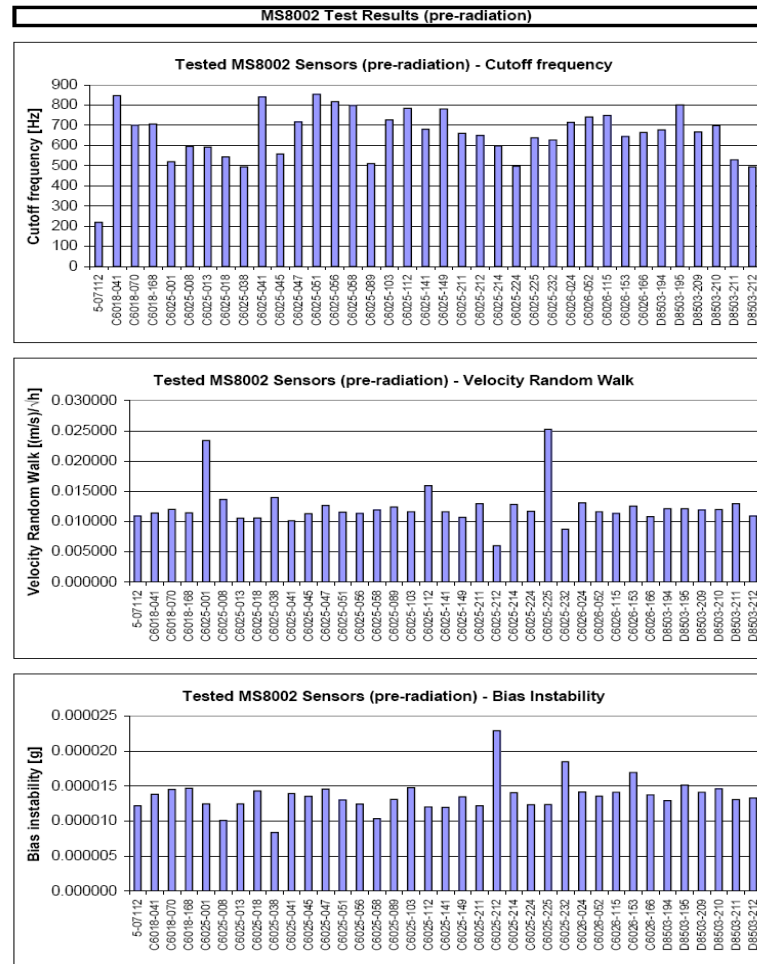
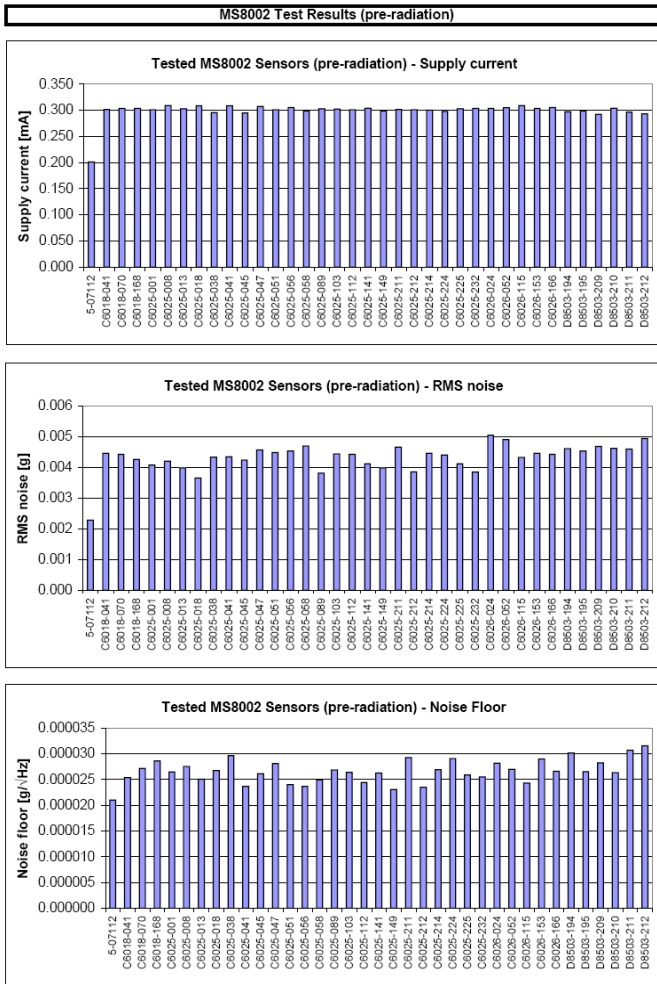
This document is the property of Astrium. It shall not be communicated to third parties without prior written agreement. Its content shall not be disclosed.

Preliminary Results

Accelerometers

Pre irradiation measurements

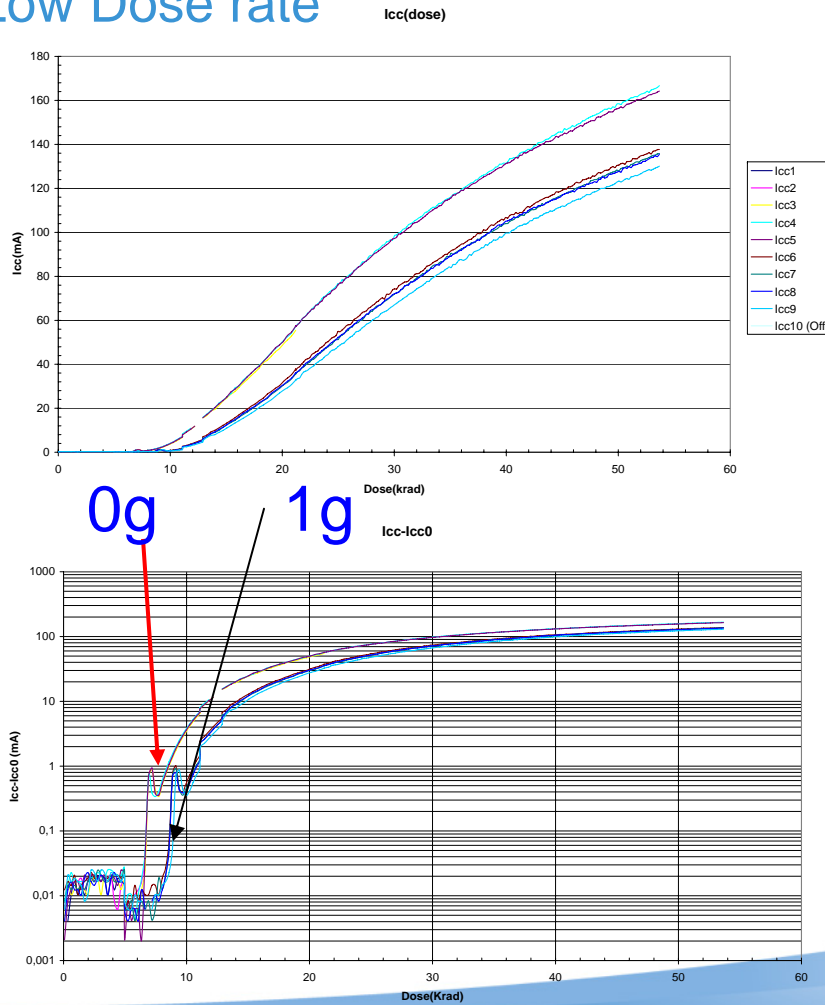
This document is the property of Astrium. It shall not be communicated to third parties without prior written agreement. Its content shall not be disclosed.



Preliminary Results

Accelerometers TID

On line measurements Power supply Current Low Dose rate



- Strong increase of power supply current

Log scale:
Increase begins at 6-8 krad
Threshold related to input: 1g or 0g

This document is the property of Astrium. It shall not be communicated to third parties without prior written agreement. Its content shall not be disclosed.

Preliminary Results

Accelerometers – Heavy Ions

Heavy ion test results

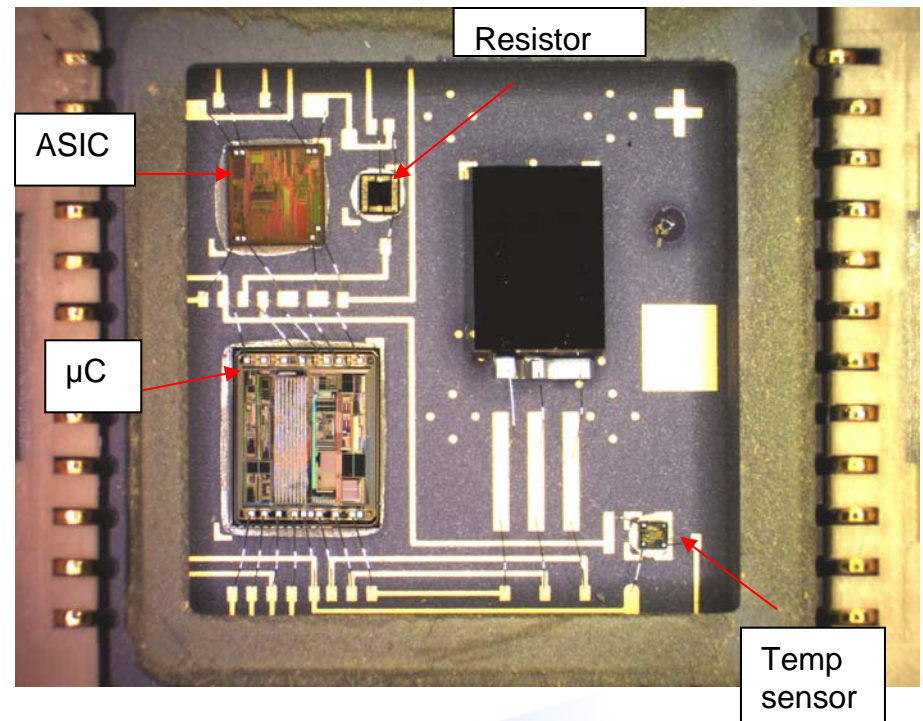
- Heavy ion range: a limitation to test sensors
- System response to heavy ions:
 - Understand the system behaviour: electrical response, calibrations, reset
 - Example of SET

Preliminary Results

Accelerometers - Heavy Ions

Separation of the contributions

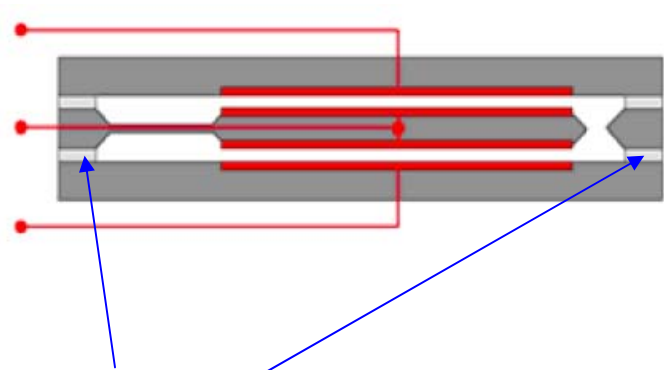
- Irradiation of one part at a time
 - Acceleration Sensor
 - Temperature sensor
 - ASIC +resistor network
 - Microcontroller (μC)
- Difficult to verify if ions do not reach other parts



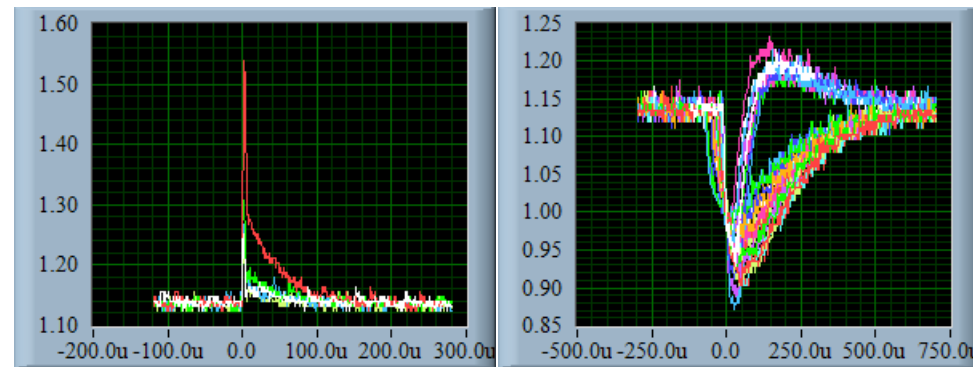
Preliminary Results Accelerometer - Heavy Ions

Tests on acceleration sensor : at 0g

This document is the property of Astrium. It shall not be communicated to third parties without prior written agreement. Its content shall not be disclosed.



OXIDE



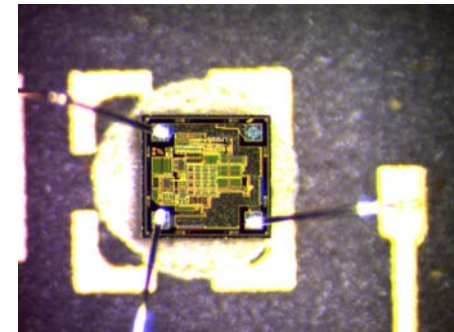
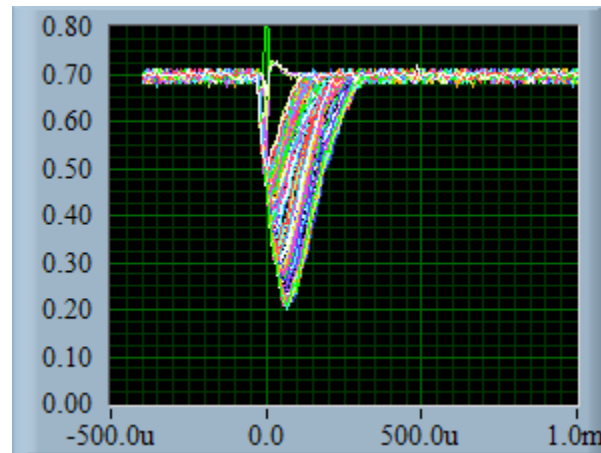
Only Heavy Ions with the highest range induce a transient

Much more negative than positive transients

Preliminary Results Accelerometer - Heavy Ions

Test on temperature sensor: LM20

Negative transients are observed
Broad variation of amplitudes



This document is the property of Astrium. It shall not be communicated to third parties without prior written agreement. Its content shall not be disclosed.

Preliminary Results

RF MEMS

Test plan : Number of sample status

Sample repartition as planned in Test plan

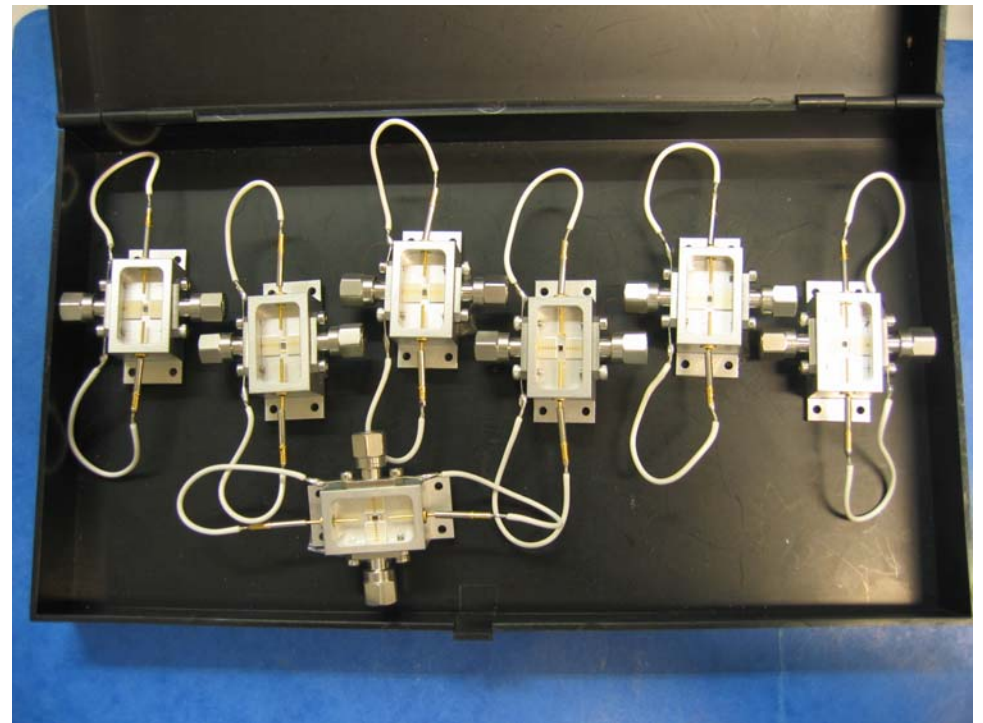
TID LDR		
Conditions	Samples	
1	3	
2	3	
3	3	
4	2	
Ref		2
Total (1) :	11	2

TID HDR		
Conditions	Samples	
x	3	
Total (2) :	3	

Heavy ions tests			
Total :	3	Ref:	2

Protons			
Total (3) :	8	Ref:	2

Total = (1) + (2) + (3) : 25 Samples
Total ref : 2 Samples



Preliminary Results RF MEMS

Focus on : Heavy ions test

- During Heavy Ions test we were looking at the following effects:
 - SET: Single Event Transients
 - Permanent Damage (increase of leakage current)
- SET: If the deposited charge in Si₃N₄ amplified by possible multiplication of charge carriers due to the Electric field
- Permanent Damage: If the heavy ion can modify the structure of the dielectric (thermal spike)

CONCLUSION (1/2)

Preliminary Conclusion on TID & Heavy Ions testing: Accelerometers

- TID : Increase of power supply current starts at 6 – 8 krad
- Heavy Ions:
 - No Latch-up observed
 - SET's observed on acceleration sensing element, temperature sensor
- Next : Deep Analysis on-going with MEMS manufacturer « Colibrys »
 - Protons Testing results
 - TID testing results
 - Heavy Ions

CONCLUSION (2/2)

Preliminary Conclusion on Heavy Ions testing: RF MEMS

- No SET observed
- No significant increase of leakage current
- Pre-radiation and post-radiation measurements:
 - Shift of V_{pin} and V_{pout} by about 5 V on all samples including non irradiated piece. Voltage shift is even larger on non irradiated parts.
 - Heavy ion radiation effects cannot be demonstrated with before/after irradiation measurement comparison.
- Next : Testing with Protons (Analysis on-going) and Dose (gamma) testing